



ILD integration studies : Gaps Barrel-endcaps

C.Clerc

LLR, Ecole polytechnique, Palaiseau

Contributions from :

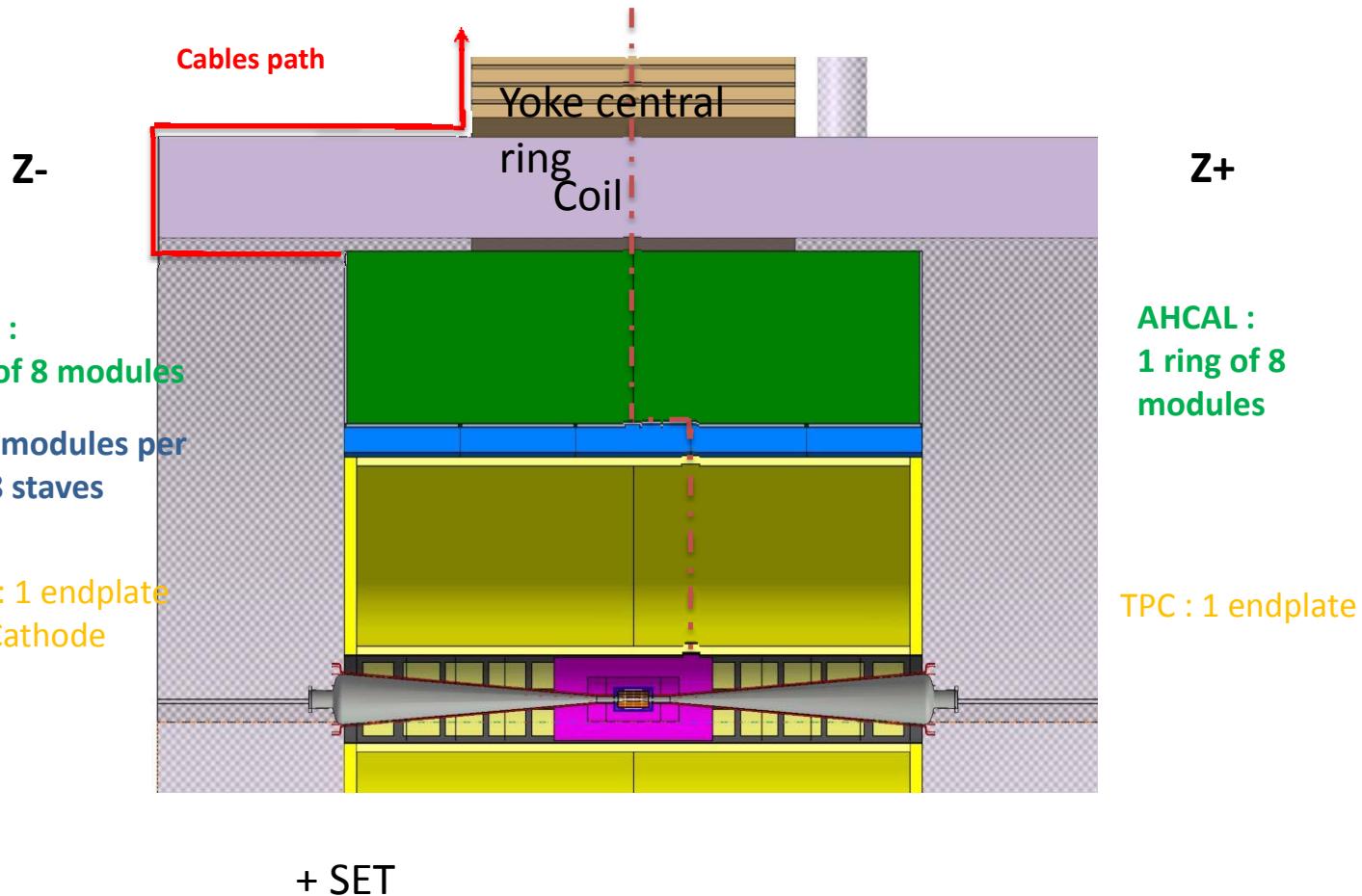
ECAL : J.Giraud, D.Grondin, D.Jaussaud

LPSC, Grenoble

DHCAL : J.C.Ianigro,

IPNL

TPC : R.Settles, T.Matsuda

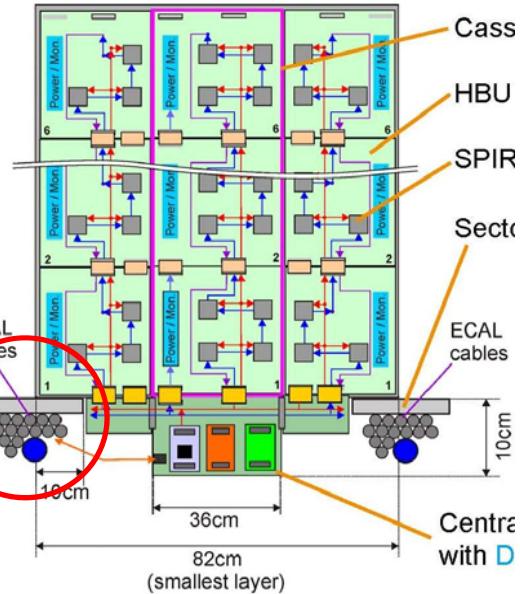
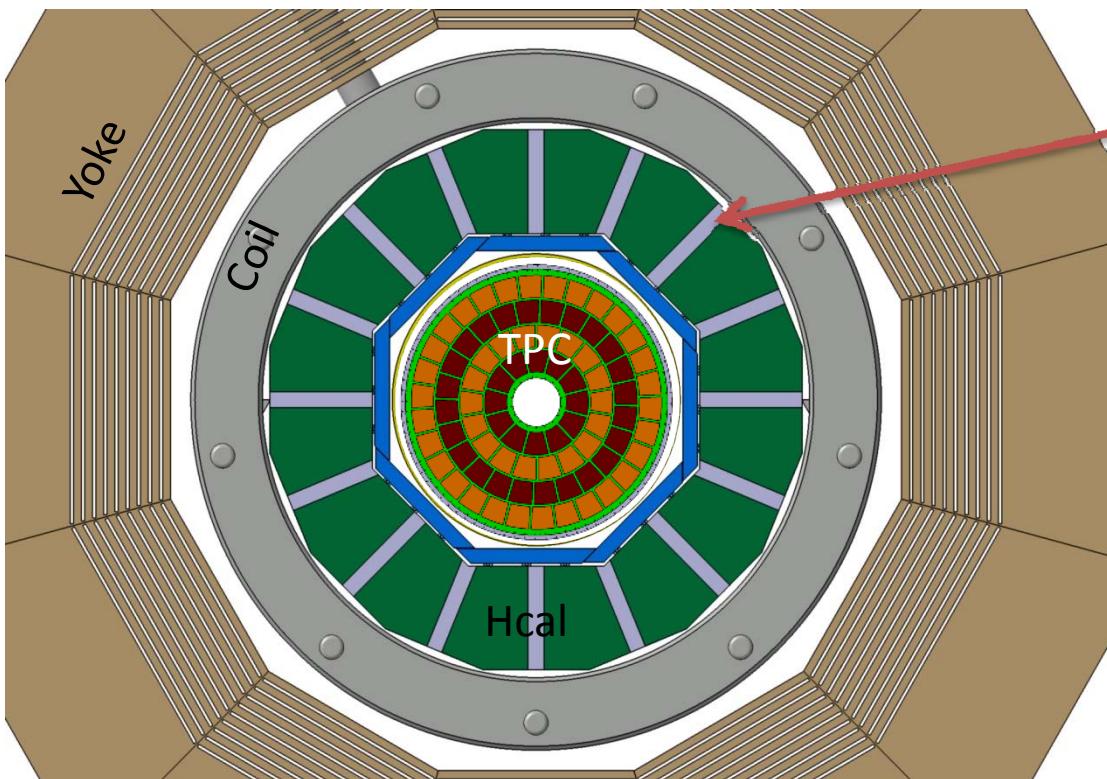


For each side :

16 way-out zones for barrel cables
 (Hcal/Ecal/TPC)

20 cm large each; gap 10 cm; thickness support 1.5 cm

170 cm²



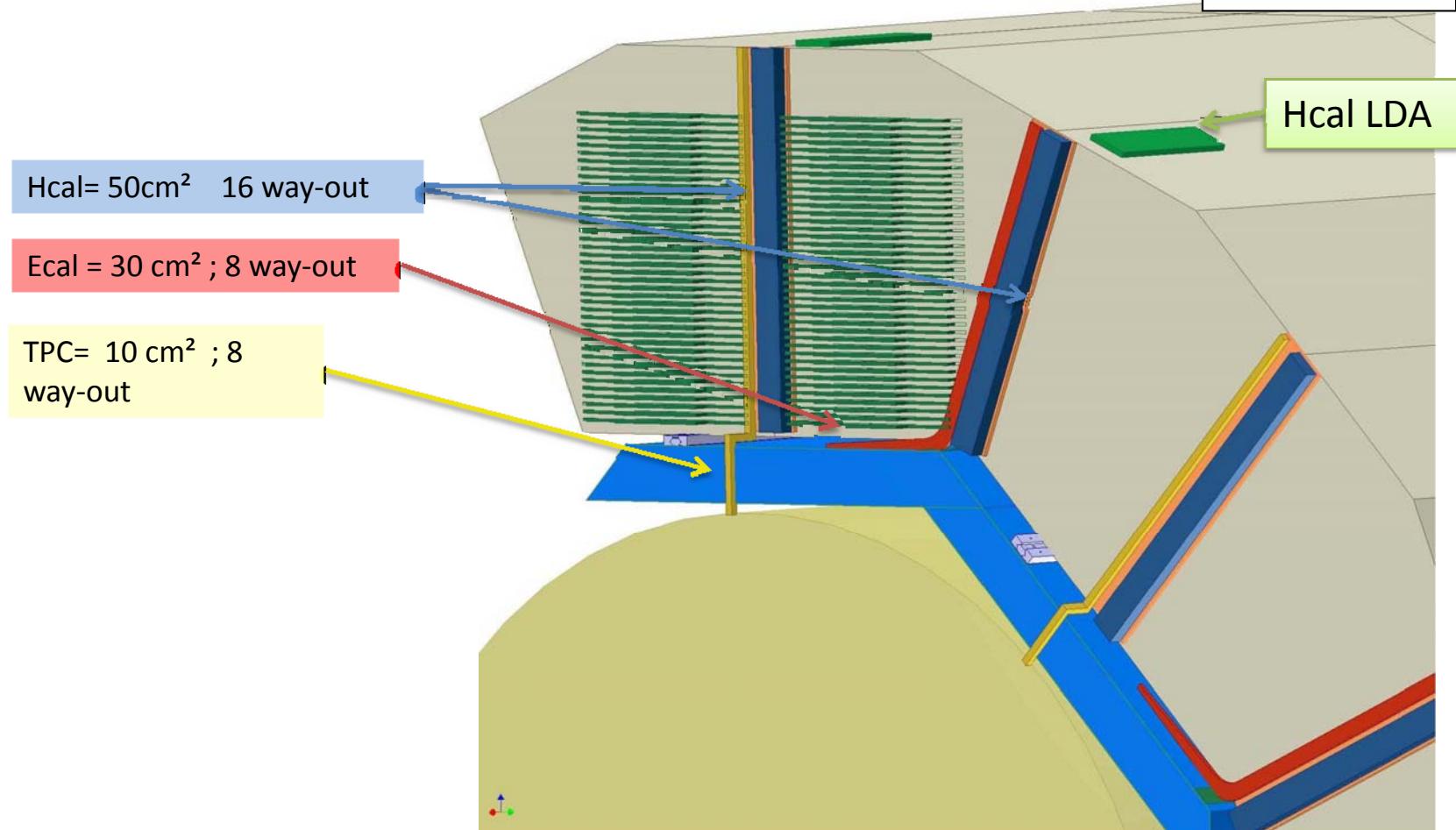
AHCal : Electronic representation
 of 1 layer ; From K.Gadow

On Hcal modules faces :

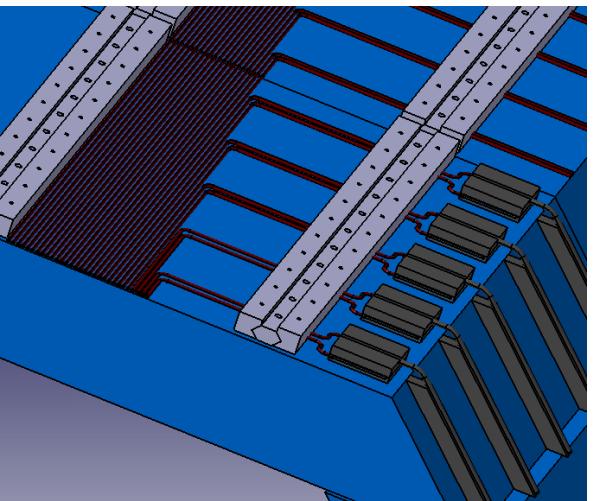
Red : Ecal cables

Blue : Hcal cables

yellow : TPC

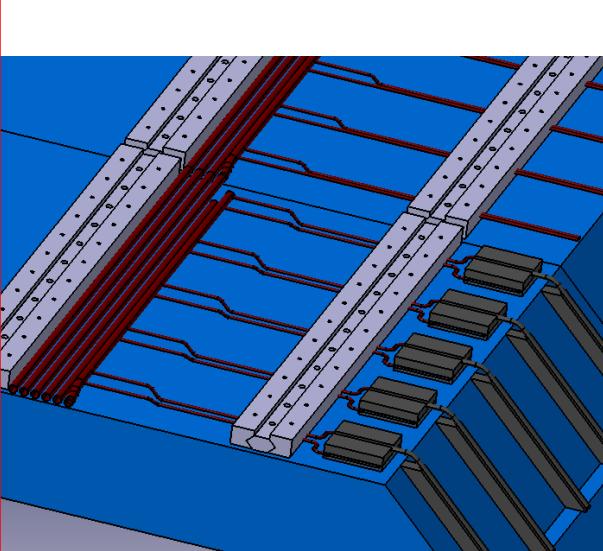


COOLING ECAL Barrel, 3 possibilities, leak less system with heat pipes .
(J.Giraud & al, LPSC)



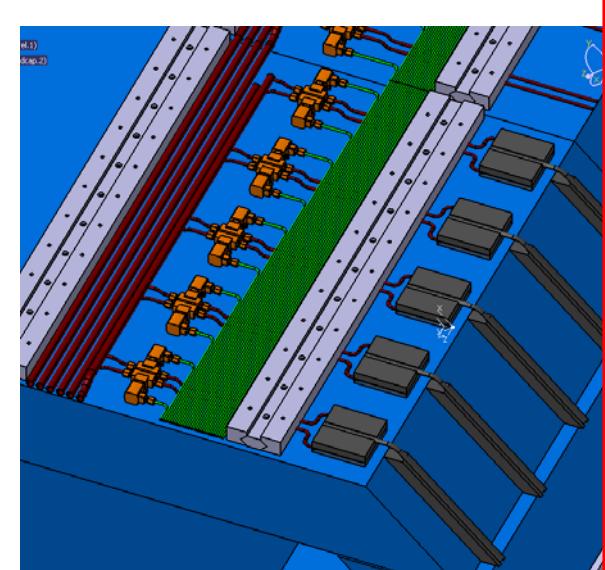
(1)
Small Cu pipes
distributing each
columns

400 tubes full barrel
15 W max



(2)
2 bigger pipes per
modules

80 tubes full barrel
150 W

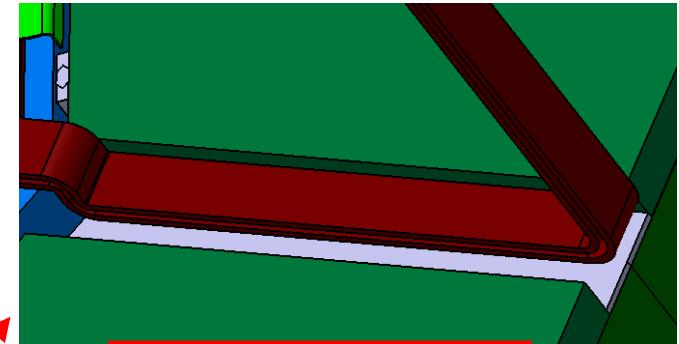
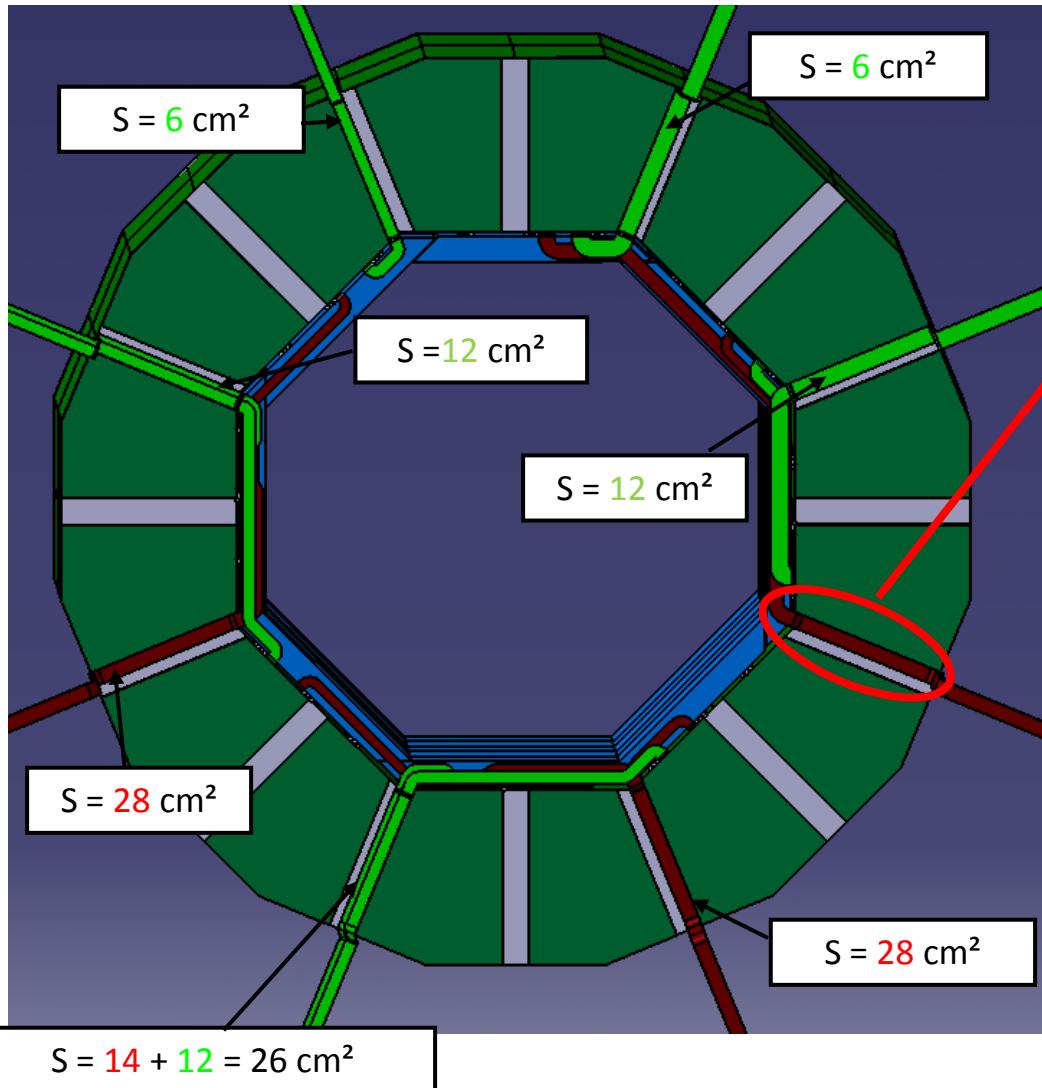


(3)
Same as (2) + pneumatic
valves

80 (water) + **400 (air)**

150 W

Green : air path
Red : water pipes



$S_{\max} = 42 \text{ cm}^2$
3 overlapped lines of 6 pipes
 $\varnothing 15 \text{ mm}$

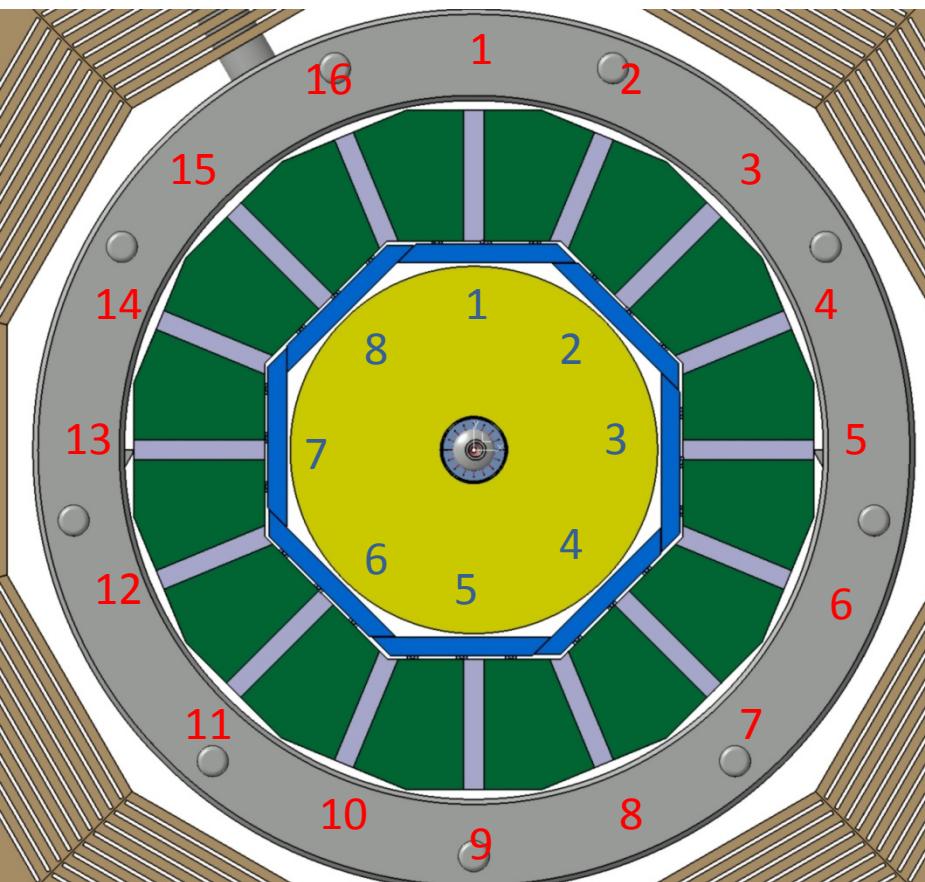
COOLING ECAL Barrel
(J.Giraud & al, LPSC)

Services section vs way-out

Missing : TPC cooling

Liquid supply line = 5 mm ID; 7 OD

Vapor return = 8 mm ID; 10 OD



Way in	Cables			cooling		Total cm ²
	Hcal	TPC	Ecal	Water	Air	
1	50	10				60
2	50		30		6	86
3	50	10				60
4	50		30		12	92
5	50	10				60
6	50		30	42		122
7	50	10				60
8	50		30	28		108
9	50	10				60
10	50		30	14	12	106
11	50	10				60
12	50		30	28		108
13	50	10				60
14	50		30		12	92
15	50	10				60
16	50		30		12	92

(170 cm² available per path)

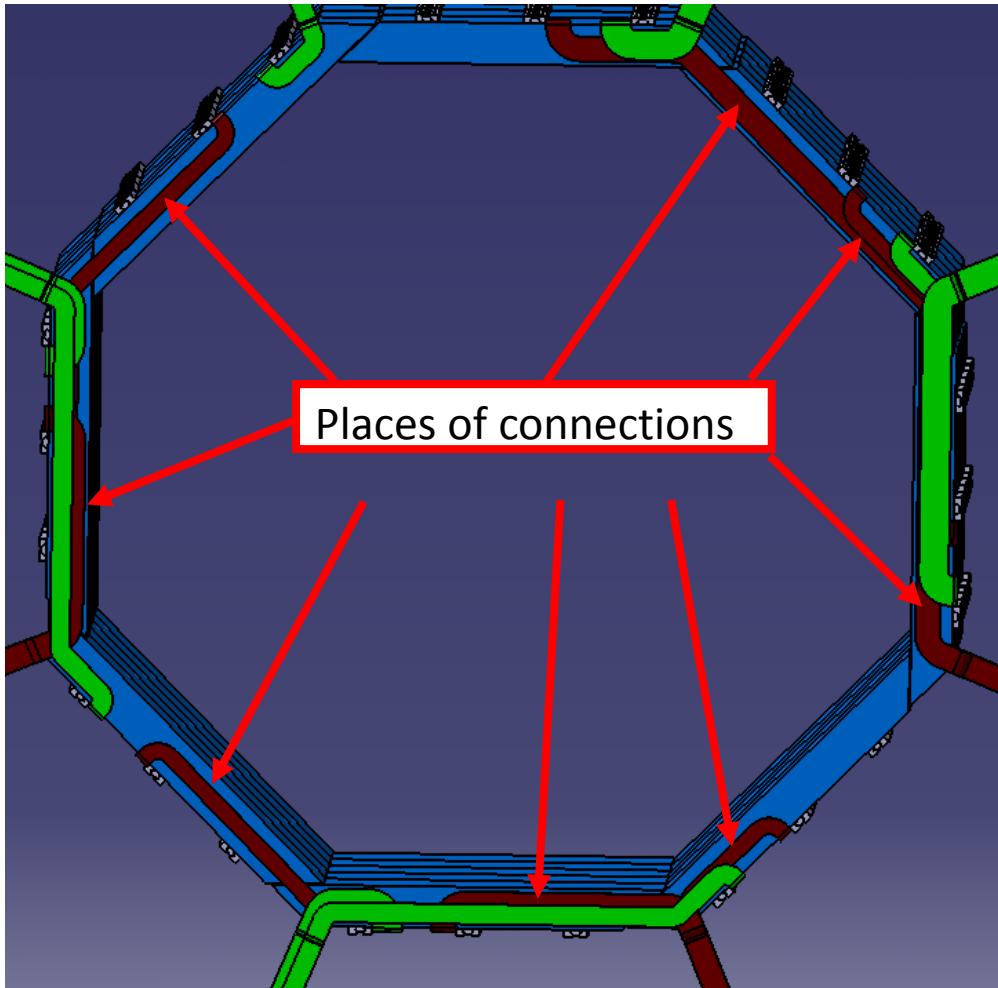
Worse case : path (6), 122 cm²

Means 6.1 cm thick full

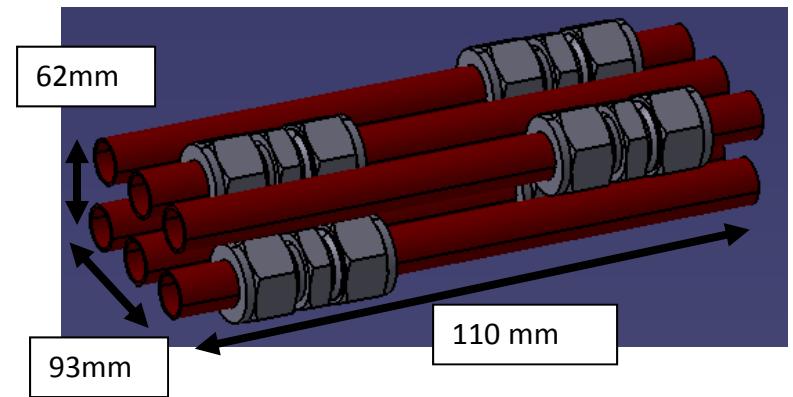
Foreseen gap of 10 cm is enough

Ahcal electronic boards ?

Another limitation to the minimal size of the gaps is the patch panels



3 modules : $S = 58 \text{ cm}^2$



+ overlap with cables and air pipes.

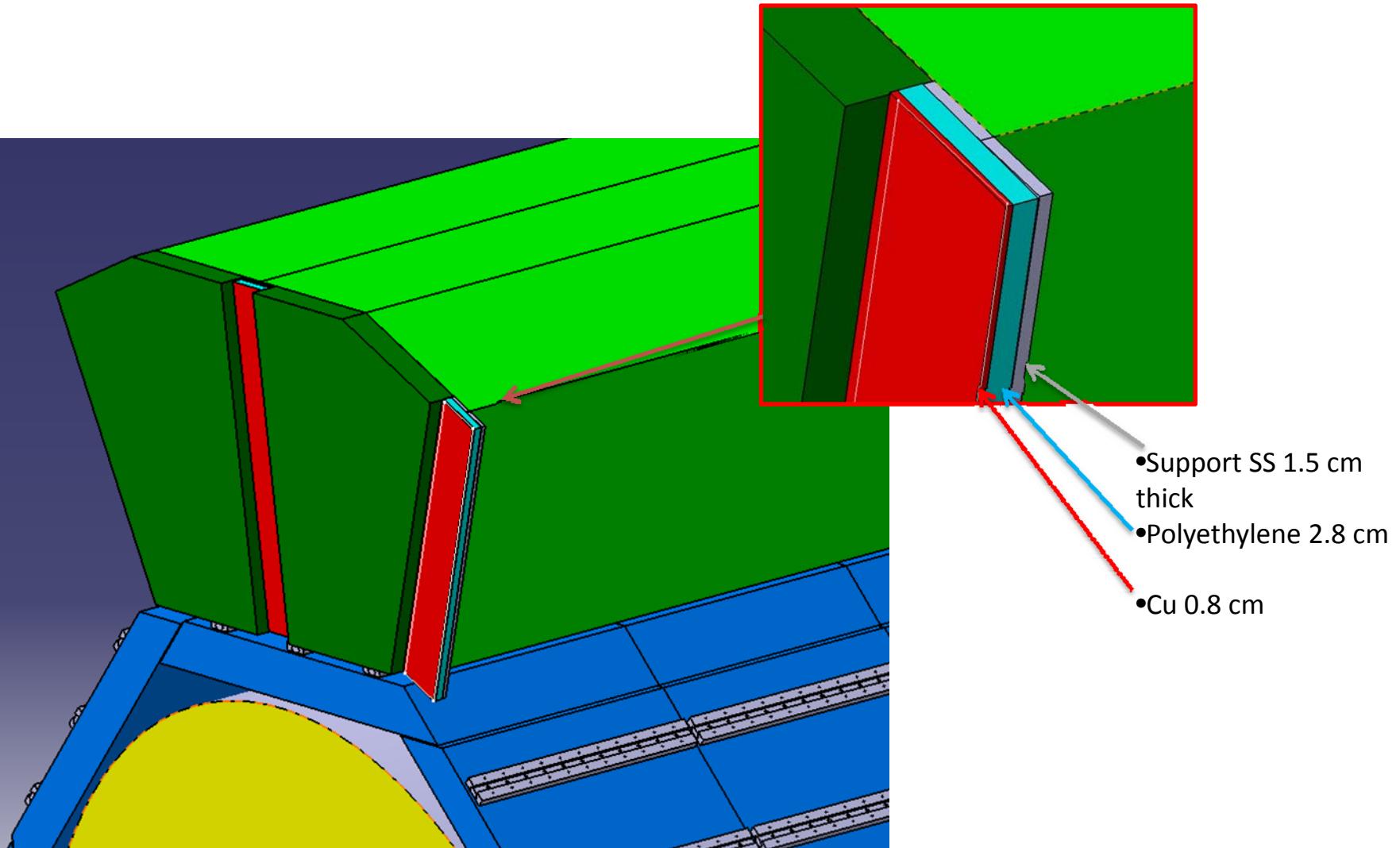
Barrel services : dead materials

Copper
X0=1,43 cm

Polyéthylène
X0= 47 cm

Way in	Cables			cooling		path width =20 cm			Cables			cooling		path width =20 cm			
	Hcal	TPC	Ecal	Water	Air	Total cm ²	thickness	X0	Hcal	TPC	Ecal	Water	Air	Total cm ²	thickness	X0	
1	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
2	10		7			17	0,85	59,44%	40	0	23		3	66	3,3	7,02%	
3	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
4	10		7			17	0,85	59,44%	40	0	23		6	69	3,45	7,34%	
5	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
6	10		7	7,9		24,9	1,245	87,06%	40	0	23			63	3,15	6,70%	
7	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
8	10		7	5,2		22,2	1,11	77,62%	40	0	23			63	3,15	6,70%	
9	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
10	10		7	2,6		19,6	0,98	68,53%	40	0	23		6	69	3,45	7,34%	
11	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
12	10		7	5,2		22,2	1,11	77,62%	40	0	23			63	3,15	6,70%	
13	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
14	10		7			17	0,85	59,44%	40	0	23		6	69	3,45	7,34%	
15	10	3				13	0,65	45,45%	40	7	0			47	2,35	5,00%	
16	10		7			17	0,85	59,44%	40	0	23		6	69	3,45	7,34%	
				average		16,31	0,82	57,01%						average	56,69	2,83	6,03%

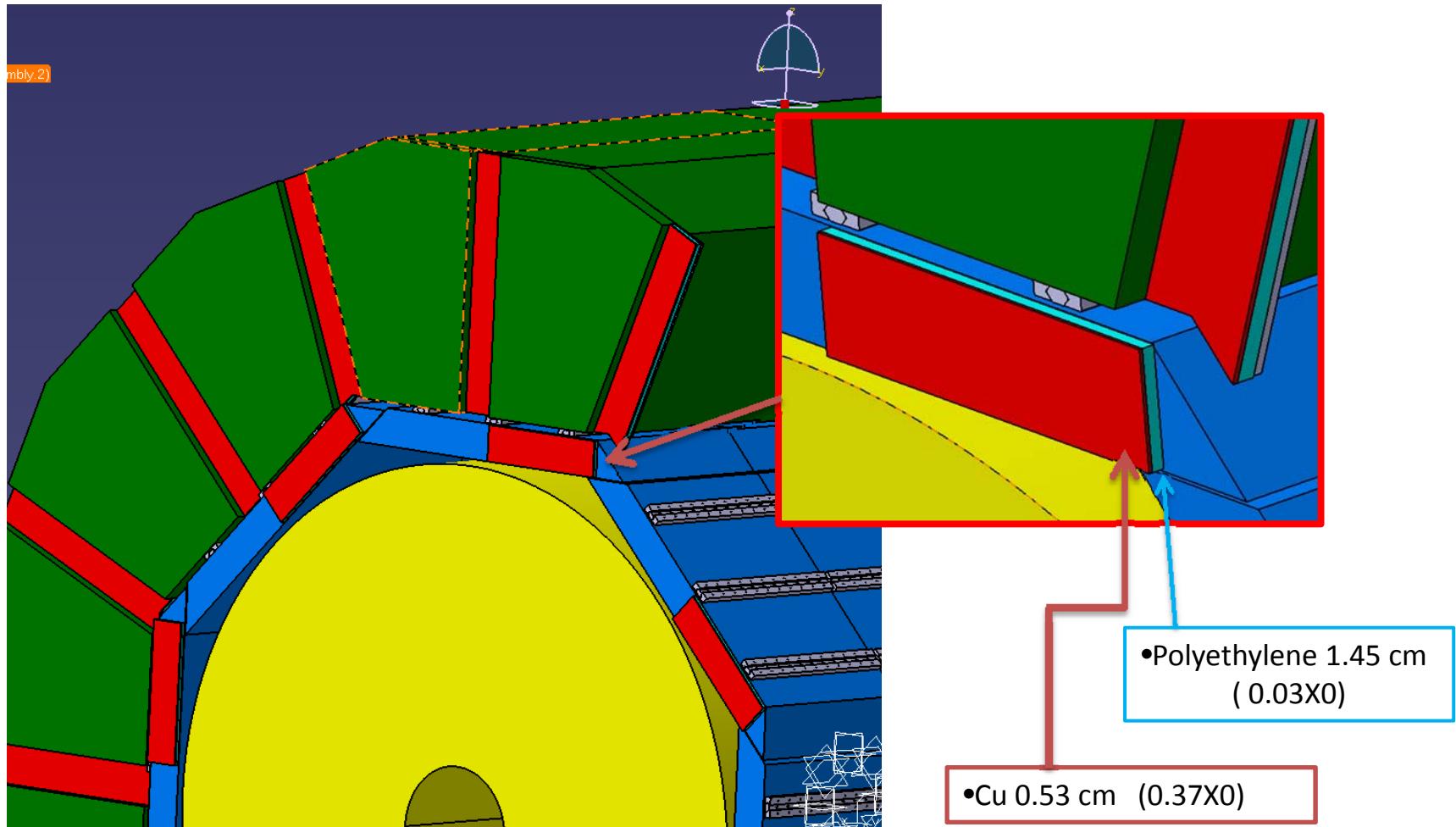
To keep a symmetry for simulation , is it possible to consider an average repartition in each of the 16 ways alongside the HCAL face? (From Inner radius of Ecal to outer radius Hcal)



For simulation, same for Ecal?

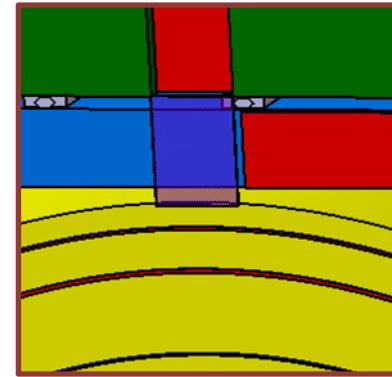
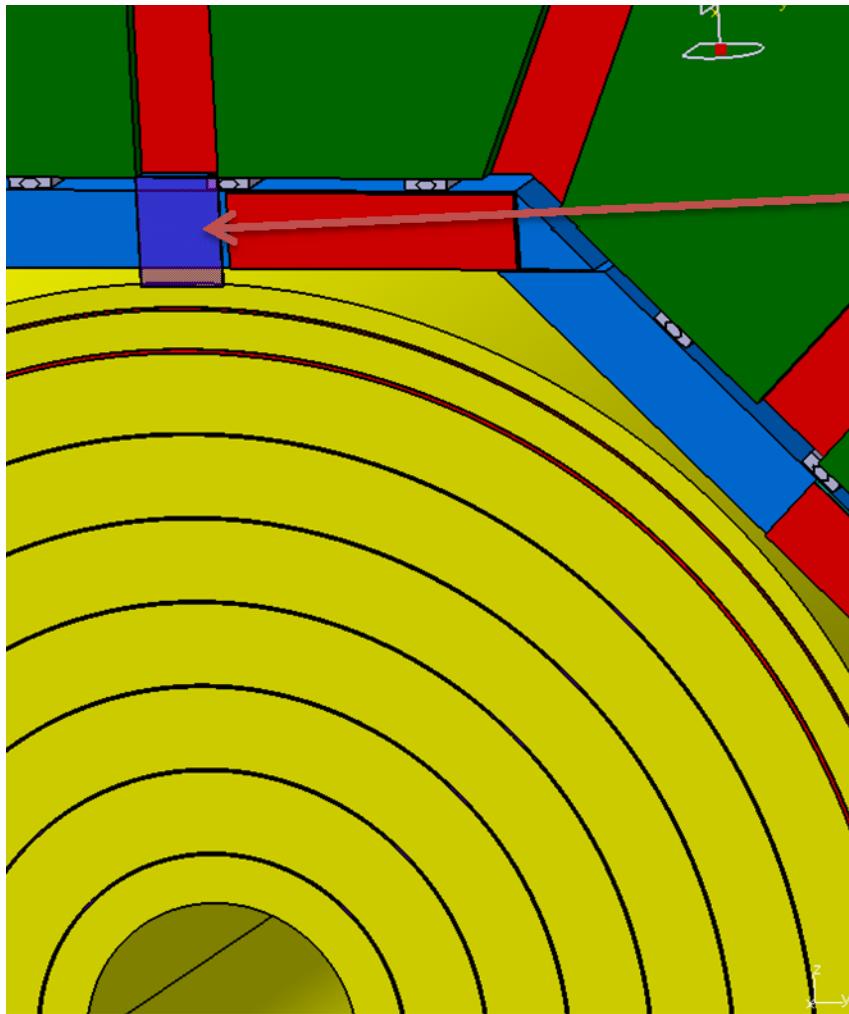
Coverage of half of the surface of each supermodule edge

Here, only 8 ways-in for ECAL



Reminder : this is for Z- face : in Z+ numbers are minorized By 2/3 for ECAL

TPC for simulation : average on 8 way-out

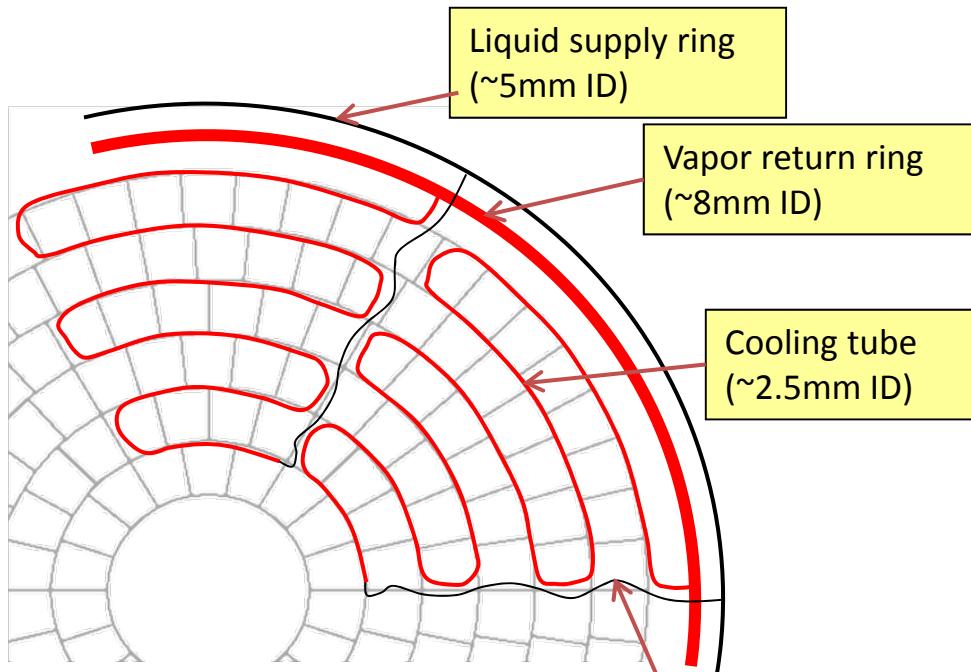


Equivalent thick. per 8 ways-out :

- Cu : 1.5 mm X 200 mm
- PE : 3.5 mm X 200 mm

CO_2 cooling of an endplate with Timepix readout

Bart Verlaat, Nikhef, LCTPC collaboration meeting, September 2009

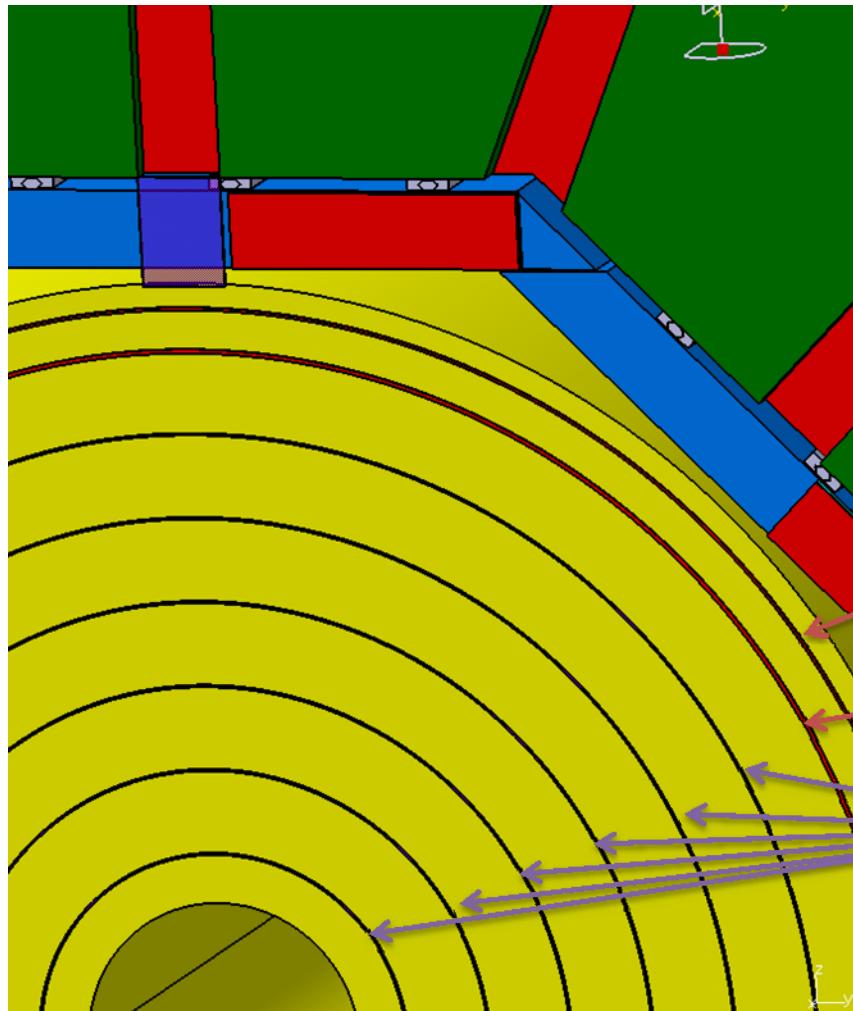


	Qty Frames / loop	Heat load per loop (W)	Tube length (m)	Inner diamete r (mm)
1 loop	200	1000	48m	6.2
2 loops	100	500	24m	4.3
4 loops	50	250	12m	3
6 loops	34	171	8m	2.2

May be represented in simulation by rings of equivalent thickness in copper ?

	width of ring (mm)	thickness of Cu (mm)	X0%
Liquid supply	7	2,7	18,88%
vapor return	10	2,8	19,58%
Cooling tube	4	1,9	13,29%

Or by a average on all the surface of the endplates?
0.62% X0



rings of equivalent thickness in copper ?

Liquid supply ring $7 \times 2.7 \text{ mm}^2$

Vapor return ring $10 \times 2.8 \text{ mm}^2$

6 Cooling tubes $4 \times 1.9 \text{ mm}^2$

X_0 Thicknesses (slide from mtg103)

Sum of these plus S-Altros
 ~ 5 % X_0

Dan estimated at last meeting
 the space-frame thickness
 ~ 8 % X_0 for the LP size. We
 don't know yet how this
 translates to the LCTPC size.

Cooling (my guess, needs
 confirmation)

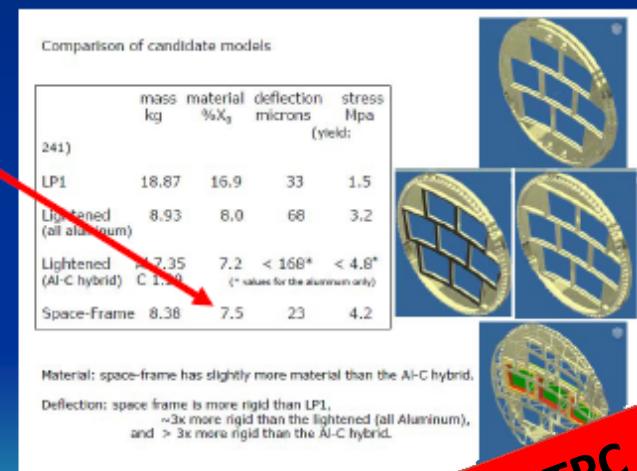
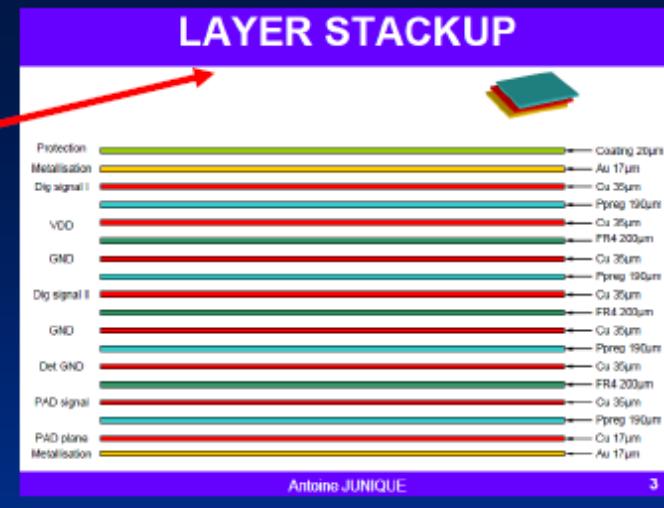
~ 2% X_0

On PCB Board

Cable layout --- work in
 progress --- but it looks like the
 above X_0 may be doubled.

06/05/2010

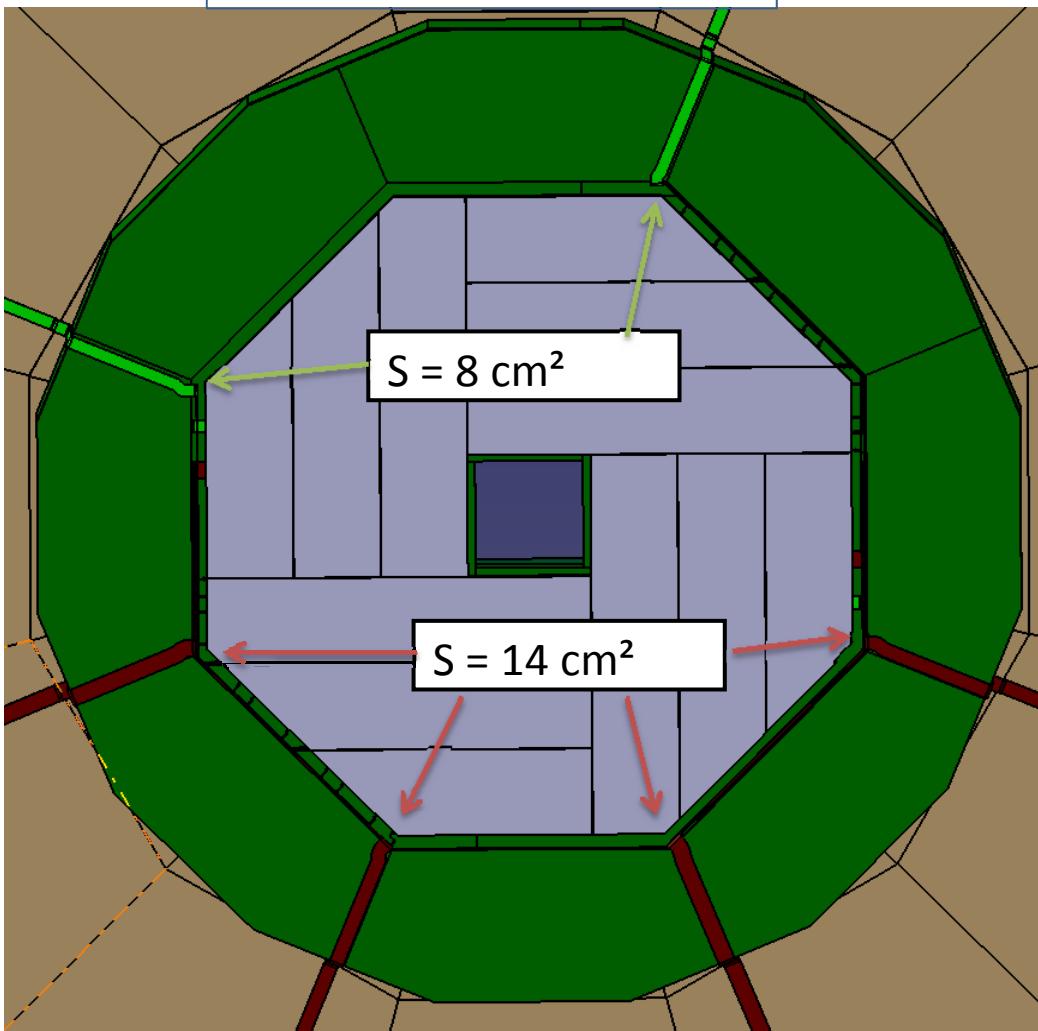
Ron Settles MPI-Munich
 LCTPC integration model



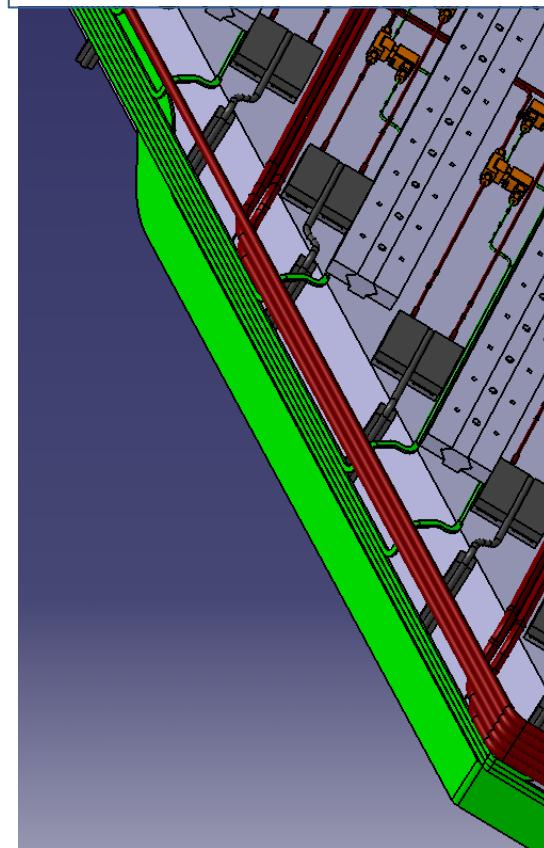
Work in progress in LCTPC

21

front view :
gap endcap/barrel



Back view :
gap Ecal/Hcal endcap



Warning : on those drawings , the ways-out are just opposite to those of Barrel .
Have to be reconsidered

Cables and services from the endcaps in the gap

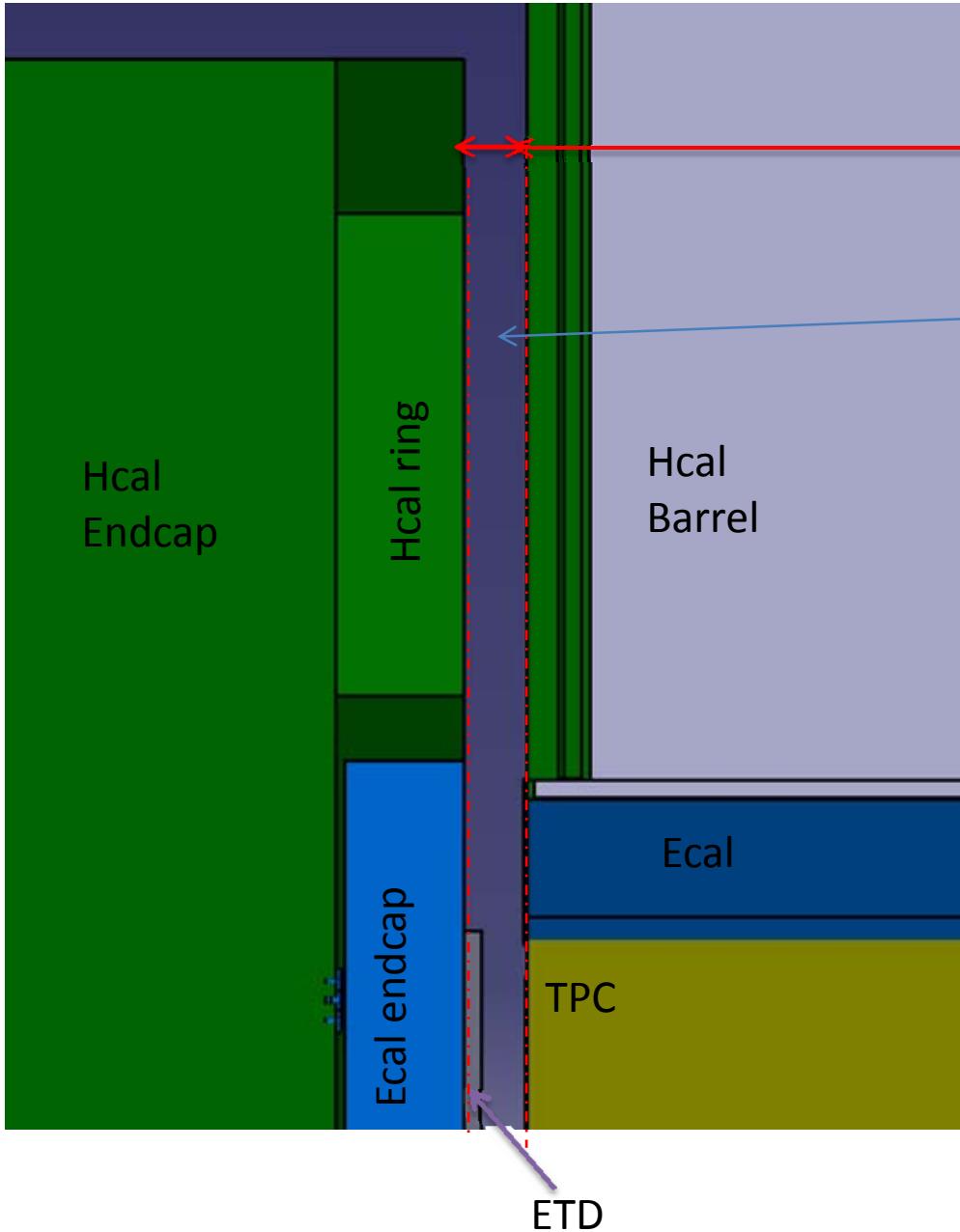
Barrel/endcaps:

Ecal :

- Cooling = 56 cm² (minimal thickness 1.5 cm)
- Air = 16 cm²
- Cables (?)= 15Mch ≈ 53 cm²

ETD: not yet considered.

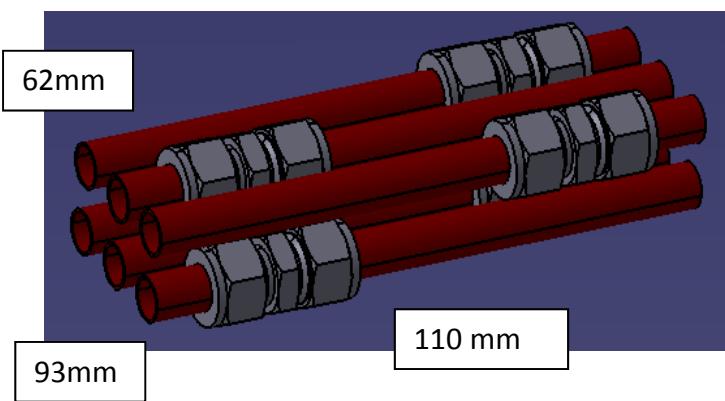
To be distributed on all the circumference except in front of the 16 ways reserved to barrel : 810 cm; seems far enough !



Gap of 10 cm

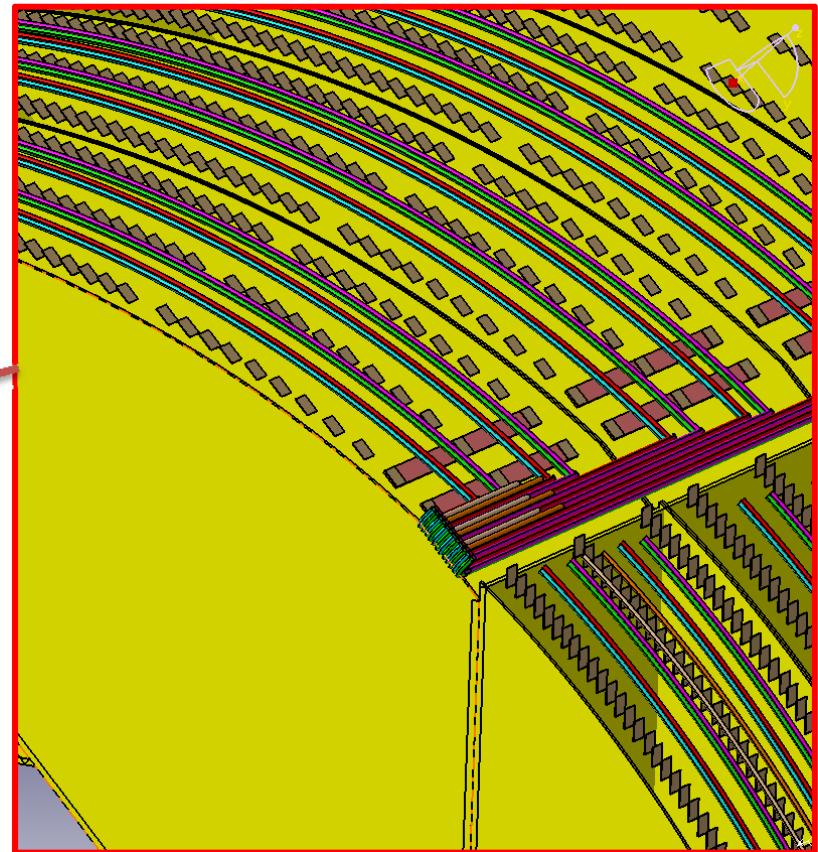
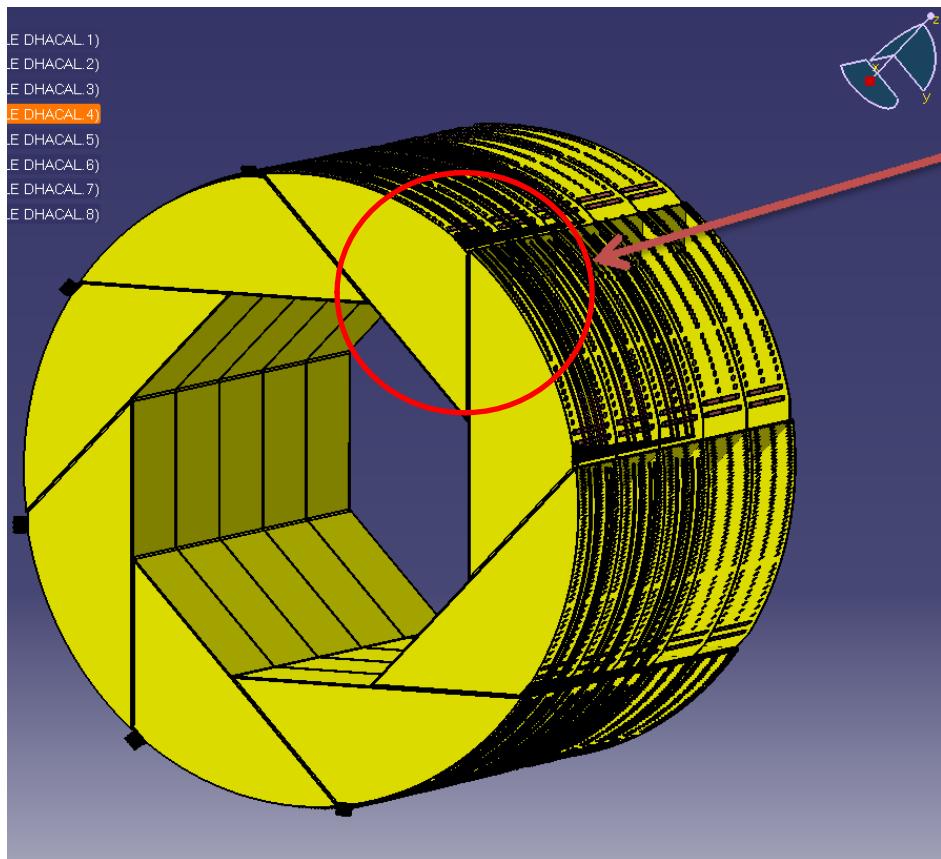
Electronic board of AHCal : x cm

Way N°6: 72cm² for Ecal .
Overlaps have to be checked as
room for connections .



ETD structure : 4 cm thick.

From J.C.Ianigro, IPNL



Services and cables in the gap between
Hcal & coil cryostat

•**Gap Barrel/Endcap :**

- ✓ No services : save 50 cm² X16 (Cables AHCAL)
- ✓ The other services ECAL&TPC may be distributed other 360 °
 - ⇒ Possible reduction of the gap thickness
(but still limited by patchpanels Ecal)
- ✓ Thickness of the structural wall of the outer modules (15 mm of stainless steel ? (i.e. 0.85 X0)

•**Gap DHCAL/ Coil cryostat** : actually is 35 mm

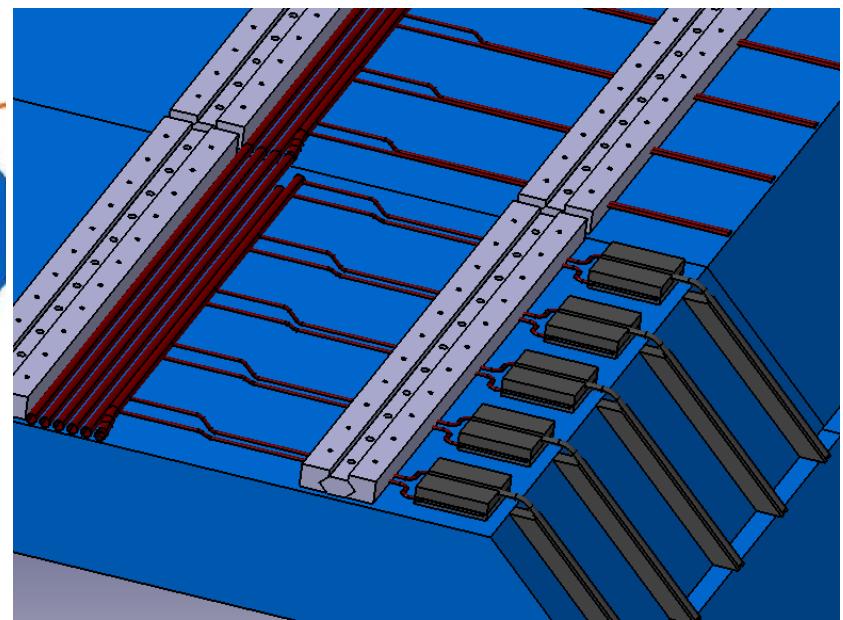
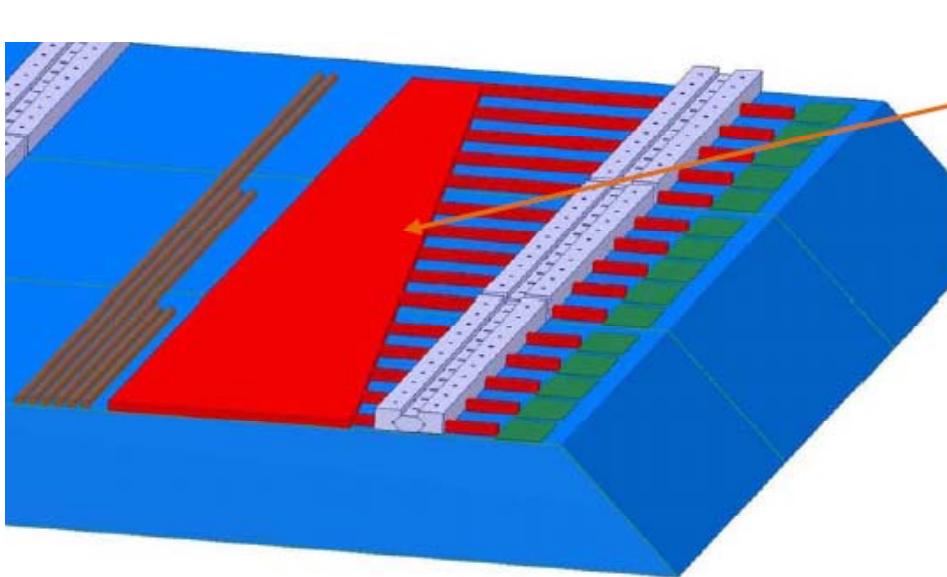
- ⇒ Certainly not enough for electronic Boards, services/cables
Need to be checked

For October's meeting :

✓ Update the CAD drawings with more detailed placeholders

✓ Ecal :

- Choice of the Ecal cooling solution ?
- Average material for simulation in the gap Ecal/Hcal Barrels



Cabling 30cm²+Elec.
Boards



Cooling: pipes 14 cm² and heat
exchanger

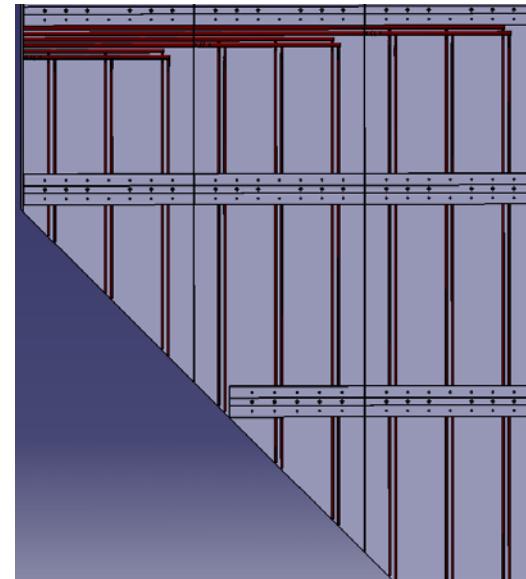
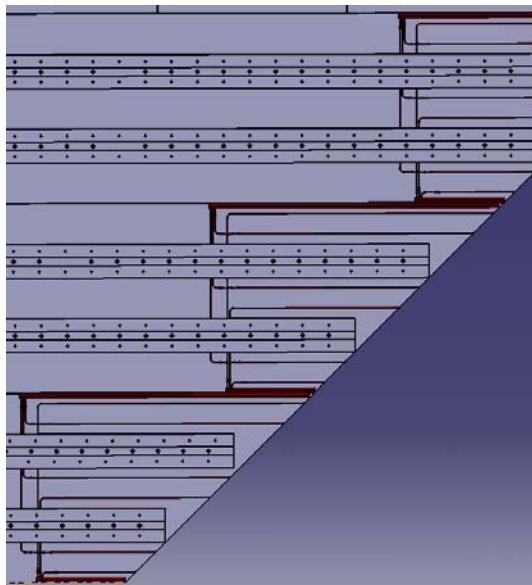
Rails

For October's meeting :

✓ Update the CAD drawings with more detailed placeholders

✓ Ecal :

- Choice of the Ecal cooling solution ?
- Average material for simulation in the gap Ecal/Hcal Barrels
- Material in the gap Ecal/Hcal endcap



Back view of Endcap solution 2 : 30 mm missing in the gap

For October's meeting :

✓ Update the CAD drawings with more detailed placeholders

✓ Ecal :

- Choice of the Ecal cooling solution ?
- Average material for simulation in the gap Ecal/Hcal Barrels
- Material in the gap Ecal/Hcal endcap

✓ AHcal :

- Front end board dimensions and its X0%?

✓ DHcal:

- Second CAD model
- Work on gap Barrel/Coil cryostat

✓ Inner region :

- beginning the same work if enough inputs

(see M.Jore's talk)